

# CMPA5585030F

30 W, 5.5 - 8.5 GHz, GaN MMIC, Power Amplifier

## Description

Wolfspeed's CMPA5585030F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC is available in a 10 lead metal/ceramic flanged package for optimal electrical and thermal performance.



Package Type: 440213  
PN: CMPA5585030F

## Typical Performance Over 5.8 - 8.4 GHz ( $T_c = 25^\circ\text{C}$ )

| Parameter                 | 5.8 GHz | 6.4 GHz | 7.2 GHz | 7.9 GHz | 8.4 GHz | Units |
|---------------------------|---------|---------|---------|---------|---------|-------|
| $S_{21}^{1,2}$            | 25.9    | 23.8    | 26.5    | 24.5    | 26.7    | dB    |
| Power Gain <sup>2,5</sup> | 22.3    | 19.0    | 20.9    | 21.6    | 21.2    |       |
| PAE <sup>1,2,4,5</sup>    | 24.7    | 20.7    | 20.3    | 22.6    | 22.9    | %     |
| ACLR <sup>1,2,3,5</sup>   | -37     | -42     | -33     | -34     | -40     | dBc   |

Notes (unless otherwise specified):

<sup>1</sup> At  $25^\circ\text{C}$

<sup>2</sup> Measurements are performed using Wolfspeed test fixture AD-938516

<sup>3</sup> Under OQPSK modulated signal, 1.6 Msps, PN23, Alpha Filter = 0.2

<sup>4</sup> Power Added Efficiency =  $(P_{\text{OUT}} - P_{\text{IN}}) / P_{\text{DC}}$

<sup>5</sup> Measured at  $P_{\text{OUT}} = 41 \text{ dBm}$

## Features

- 25 dB Small Signal Gain
- 30 W Typical  $P_{\text{SAT}}$
- Operation up to 28 V
- High Breakdown Voltage
- High Temperature Operation
- Size 1.00 x 0.385 inches

## Applications

- Point to Point Radio
- Communications Radar
- Satellite Communication Uplink





### Absolute Maximum Ratings (not simultaneous)

| Parameter                                       | Symbol          | Rating    | Units    | Conditions                         |
|-------------------------------------------------|-----------------|-----------|----------|------------------------------------|
| Drain-source Voltage                            | $V_{DSS}$       | 150       | $V_{DC}$ | 25°C                               |
| Gate-source Voltage                             | $V_{GS}$        | -10, +2   |          |                                    |
| Storage Temperature                             | $T_{STG}$       | -65, +150 | °C       |                                    |
| Operating Junction Temperature                  | $T_J$           | 225       |          |                                    |
| Maximum Forward Gate Current                    | $I_{GMAX}$      | 10        | mA       | 25°C                               |
| Soldering Temperature <sup>1</sup>              | $T_S$           | 245       | °C       |                                    |
| Screw Torque                                    | $\tau$          | 40        | in-oz    |                                    |
| CGHV40180F Thermal Resistance, Junction to Case | $R_{\theta JC}$ | 2.16      | °C/W     | CW, 85°C, $P_{DISS} = 66\text{ W}$ |
| Case Operating Temperature                      | $T_C$           | -40, +150 | °C       |                                    |

Note:

<sup>1</sup> Refer to the Application Note on soldering at [wolfspeed.com/rf/document-library](http://wolfspeed.com/rf/document-library)

### Electrical Characteristics (Frequency = 5.5 GHz to 8.5 GHz unless otherwise stated; $T_C = 25^\circ\text{C}$ )

| Characteristics                       | Symbol       | Min.  | Typ. | Max. | Units  | Conditions                                                                                                      |
|---------------------------------------|--------------|-------|------|------|--------|-----------------------------------------------------------------------------------------------------------------|
| <b>DC Characteristics<sup>1</sup></b> |              |       |      |      |        |                                                                                                                 |
| Gate Threshold Voltage                | $V_{GS(th)}$ | -3.8  | -2.8 | -2.3 | V      | $V_{DS} = 10\text{ V}$ , $I_{DS} = 12.7\text{ mA}$                                                              |
| Saturated Drain Current <sup>2</sup>  | $I_{DS}$     | 9.2   | 12.7 | —    | A      | $V_{DS} = 6.0\text{ V}$ , $V_{GS} = 2.0\text{ V}$                                                               |
| Drain-Source Breakdown Voltage        | $V_{BD}$     | 84    | —    | —    | V      | $V_{GS} = -8\text{ V}$ , $I_{DS} = 12.7\text{ mA}$                                                              |
| <b>RF Characteristics<sup>3</sup></b> |              |       |      |      |        |                                                                                                                 |
| Small Signal Gain                     | S21          | 22.85 | 26   | —    | dB     | $V_{DD} = 28\text{ V}$ , $I_{DQ} = 285\text{ mA}$ , $P_{IN} = -20\text{ dBm}$                                   |
| Input Return Loss                     | S11          | —     | -7   | —    |        |                                                                                                                 |
| Output Return Loss                    | S22          | —     |      | —    |        |                                                                                                                 |
| Output Mismatch Stress                | VSWR         | —     | —    | 5:1  | $\Psi$ | No damage at all phase angles,<br>$V_{DD} = 28\text{ V}$ , $I_{DQ} = 285\text{ mA}$ , $P_{OUT} = 43\text{ dBm}$ |

Notes:

<sup>1</sup> Measured on-wafer prior to packaging

<sup>2</sup> Scaled from PCM data

<sup>3</sup> Measured using network analyzer (Power = -20 dBm)



## Electrical Characteristics Continued ( $T_c = 25^\circ\text{C}$ )

| Characteristics                                | Symbol            | Min.  | Typ. | Max.  | Units | Conditions                                                                 |
|------------------------------------------------|-------------------|-------|------|-------|-------|----------------------------------------------------------------------------|
| RF Characteristics <sup>1,2,4,6</sup>          |                   |       |      |       |       |                                                                            |
| Power Added Efficiency at 5.8 GHz <sup>5</sup> | PAE <sub>1</sub>  | 19.0  | 25.8 | —     | %     | V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 285 mA, P <sub>IN</sub> = 41 dBm |
| Power Added Efficiency at 6.4 GHz <sup>5</sup> | PAE <sub>2</sub>  | 16.0  | 22.4 | —     |       |                                                                            |
| Power Added Efficiency at 7.2 GHz <sup>5</sup> | PAE <sub>3</sub>  | 16.2  | 22.0 | —     |       |                                                                            |
| Power Added Efficiency at 7.9 GHz <sup>5</sup> | PAE <sub>4</sub>  | 18.0  | 23.9 | —     |       |                                                                            |
| Power Added Efficiency at 8.4 GHz <sup>5</sup> | PAE <sub>5</sub>  | 19.2  | 25.0 | —     |       |                                                                            |
| Power Gain at 5.8 GHz                          | G <sub>P1</sub>   | 18.25 | 22.4 | —     | dB    |                                                                            |
| Power Gain at 6.4 GHz                          | G <sub>P2</sub>   | 16.35 | 20.2 | —     |       |                                                                            |
| Power Gain at 7.2 GHz                          | G <sub>P3</sub>   | 16.85 | 21.0 | —     |       |                                                                            |
| Power Gain at 7.9 GHz                          | G <sub>P4</sub>   | 17.15 | 22.2 | —     |       |                                                                            |
| Power Gain at 8.4 GHz                          | G <sub>P5</sub>   | 17.65 | 21.8 | —     |       |                                                                            |
| OQPSK Linearity at 5.8 GHz                     | ACLR <sub>1</sub> | —     | -42  | -32   | dBc   |                                                                            |
| OQPSK Linearity at 6.4 GHz                     | ACLR <sub>2</sub> | —     | -44  | -33   |       |                                                                            |
| OQPSK Linearity at 7.2 GHz                     | ACLR <sub>3</sub> | —     | -34  | -27.5 |       |                                                                            |
| OQPSK Linearity at 7.9 GHz                     | ACLR <sub>4</sub> | —     | -37  | -28   |       |                                                                            |
| OQPSK Linearity at 8.4 GHz                     | ACLR <sub>5</sub> | —     | -40  | -32   |       |                                                                            |

### Notes:

1 At 25°C

2 Measurements are to be performed using Wolfspeed CMPA5585030F-AMP

3 Measured using network analyzer (Power = -20 dBm)

4 Under OQPSK modulated signal, 1.6 Msps, PN23, Alpha Filer = 0.2

5 Power Added Efficiency = (P<sub>OUT</sub> - P<sub>IN</sub>)/PDC

6 Fixture loss de-embedded using the following offset. The offset is subtracted from the input offset value and added to the output offset value.

a. 5.8 GHz - 0.182 dB

b. 6.4 GHz - 0.200 dB

c. 7.2 GHz - 0.217 dB

d. 7.9 GHz - 0.234 dB

e. 8.4 GHz - 0.246 dB

## Electrostatic Discharge (ESD) Classifications

| Parameter           | Symbol | Class | Classification Level           | Test Methodology    |
|---------------------|--------|-------|--------------------------------|---------------------|
| Human Body Model    | HBM    | 2     | ANSI/ESDA/JEDEC JS-001 Table 3 | JEDEC JESD22 A114-D |
| Charge Device Model | CDM    | C3    | ANSI/ESDA/JEDEC JS-002 Table 3 | JEDEC JESD22 C101-C |

Typical Performance of the CPM5585030F

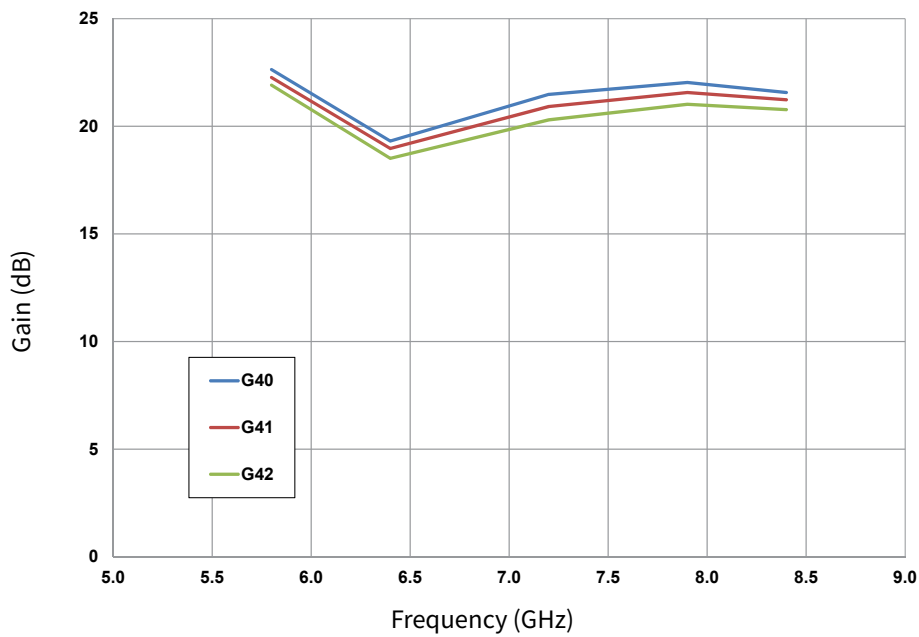


Figure 1. Gain vs. Frequency & Output Power OQPSK 1.6 Msps  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$

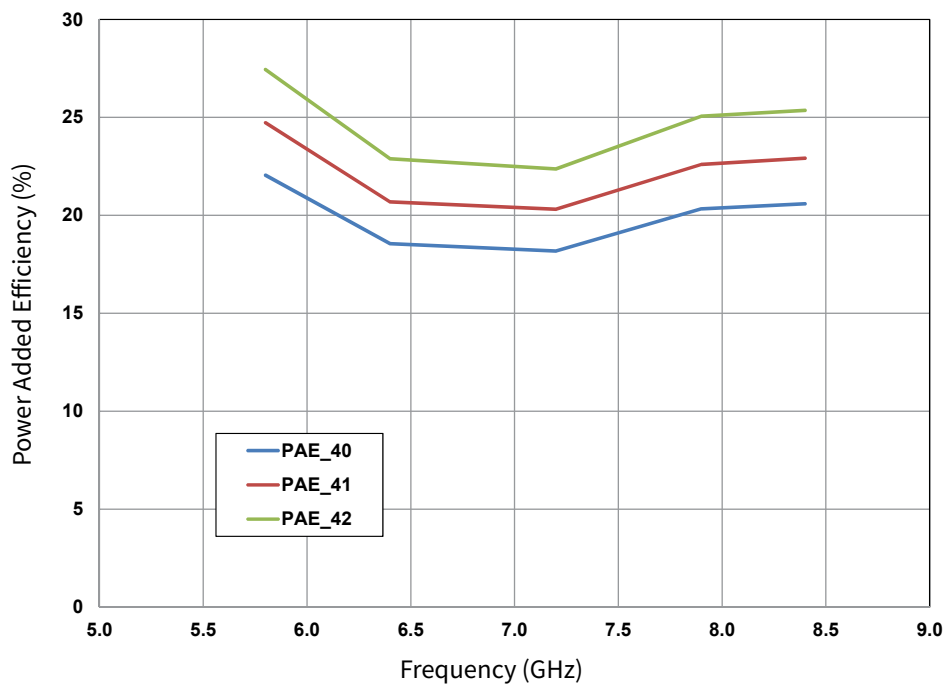
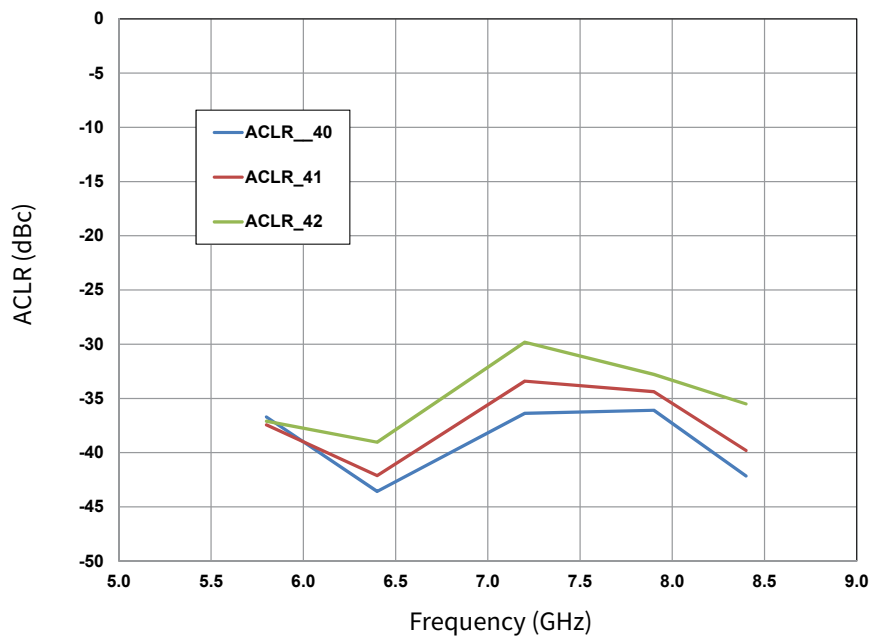
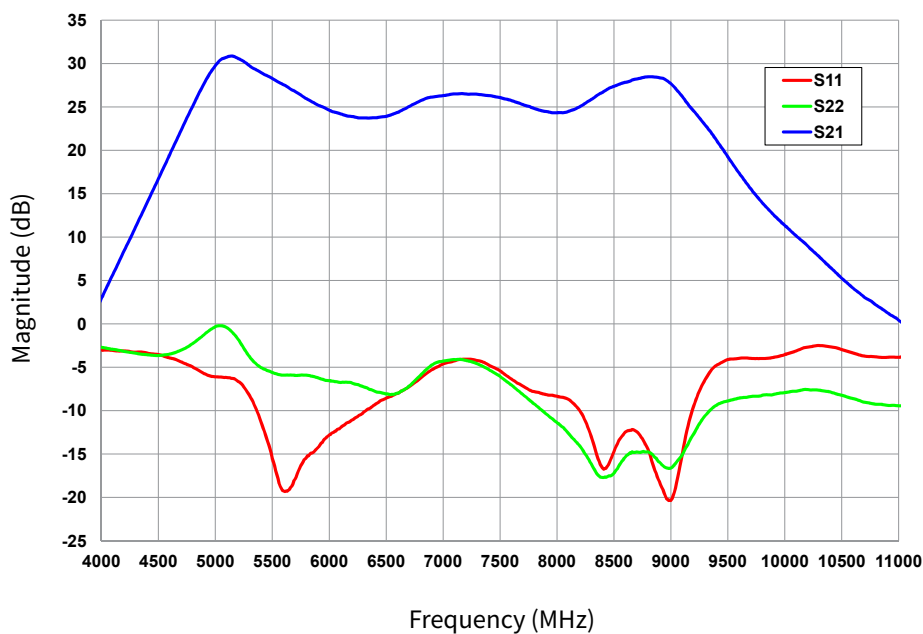


Figure 2. Power Added Efficiency vs. Frequency & Output Power OQPSK 1.6 Msps  $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$

## Typical Performance of the CPM5585030F



**Figure 3.** ACLR vs. Frequency & Output Power OQPSK 1.6 Msps  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$



**Figure 4.** Typical S-Parameters  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$

Typical Performance of the CPMA5585030F

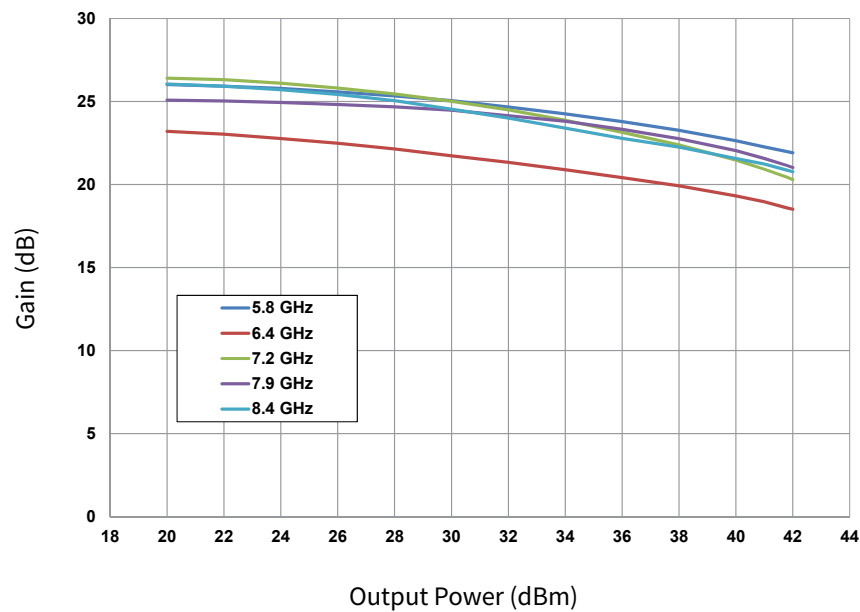


Figure 5. Gain vs. Output Power and Frequency OQPSK 1.6 Msps  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$

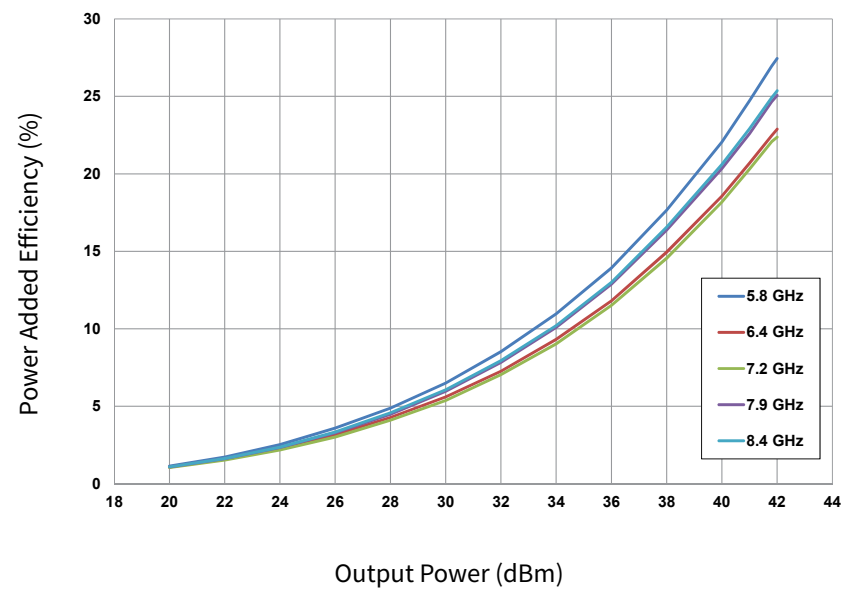
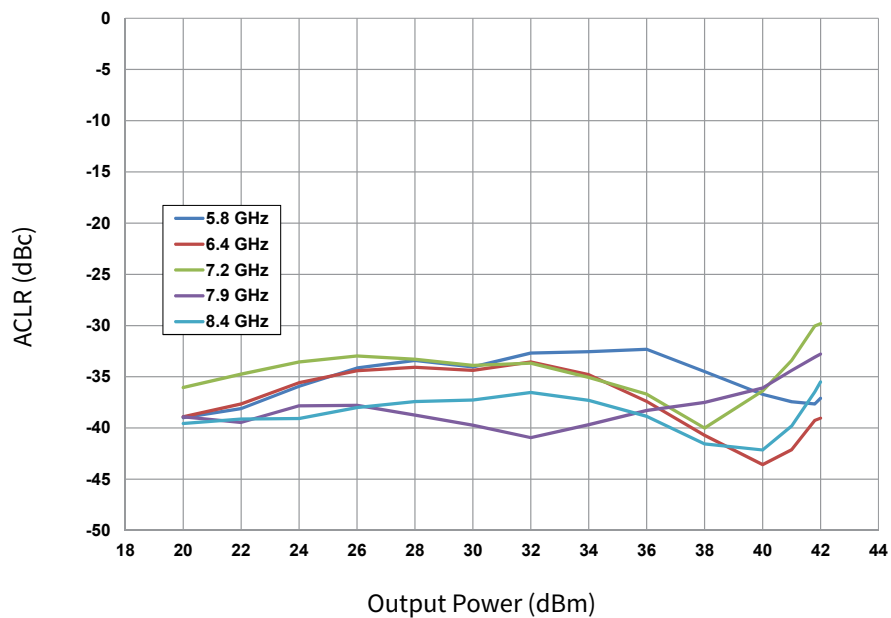
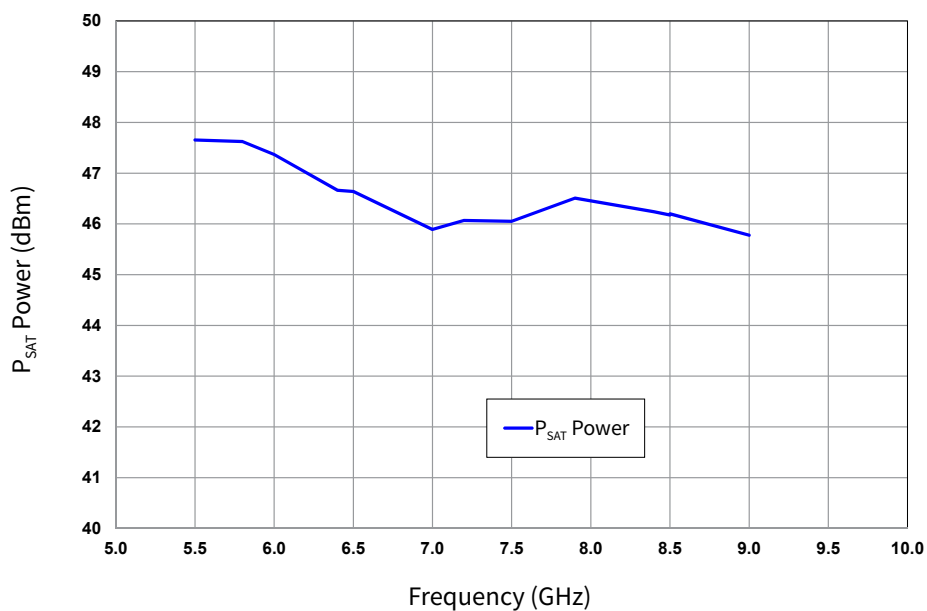


Figure 6. Power Added Efficiency vs. Output Power and Frequency OQPSK  
1.6 Msps  $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$

## Typical Performance of the CPMA5585030F

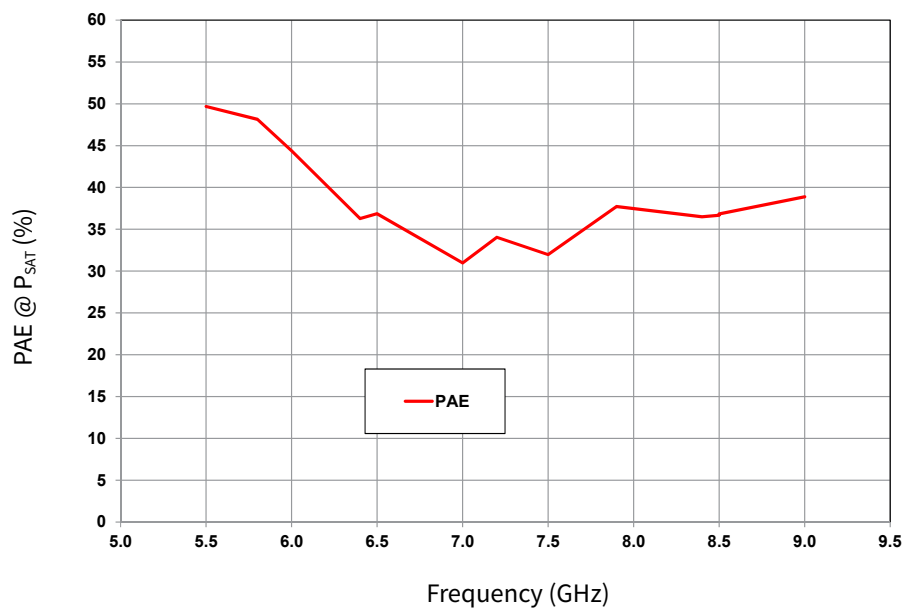


**Figure 7.** ACLR vs. Output Power and Frequency OQPSK 1.6 Msps  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 285\text{ mA}$

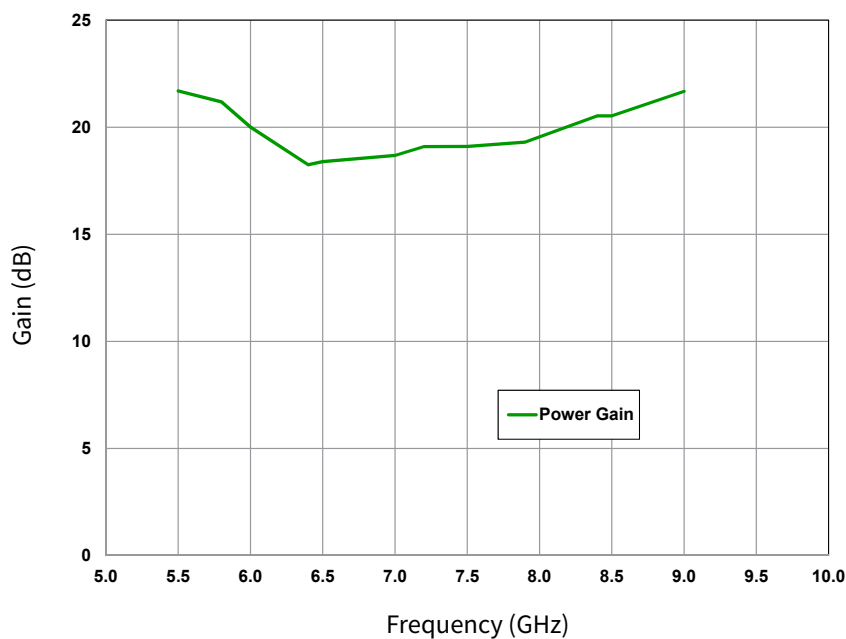


**Figure 8.**  $P_{SAT}$  Power vs. Frequency  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 800\text{ mA}$ , Pulsed Width = 100 $\mu\text{s}$ , Duty Cycle = 10%

## Typical Performance of the CMPA5585030F



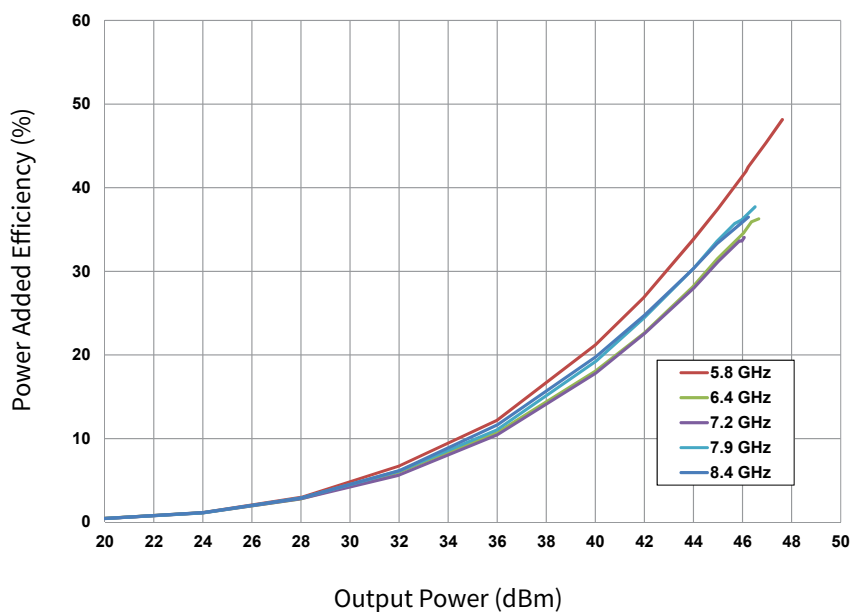
**Figure 9.** Power Added Efficiency @ Saturated Power vs. Frequency  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 800\text{ mA}$ , Pulsed Width =  $100\mu\text{s}$ , Duty Cycle = 10%



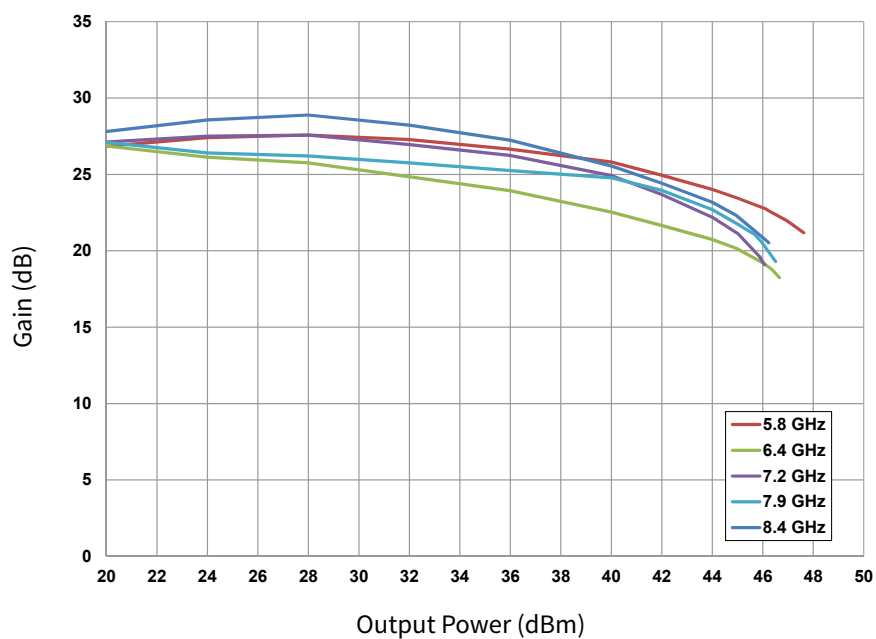
**Figure 10.** Gain @ Saturated Power vs. Frequency  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 800\text{ mA}$ , Pulsed Width =  $100\mu\text{s}$ , Duty Cycle = 10%



## Typical Performance of the CPMA5585030F

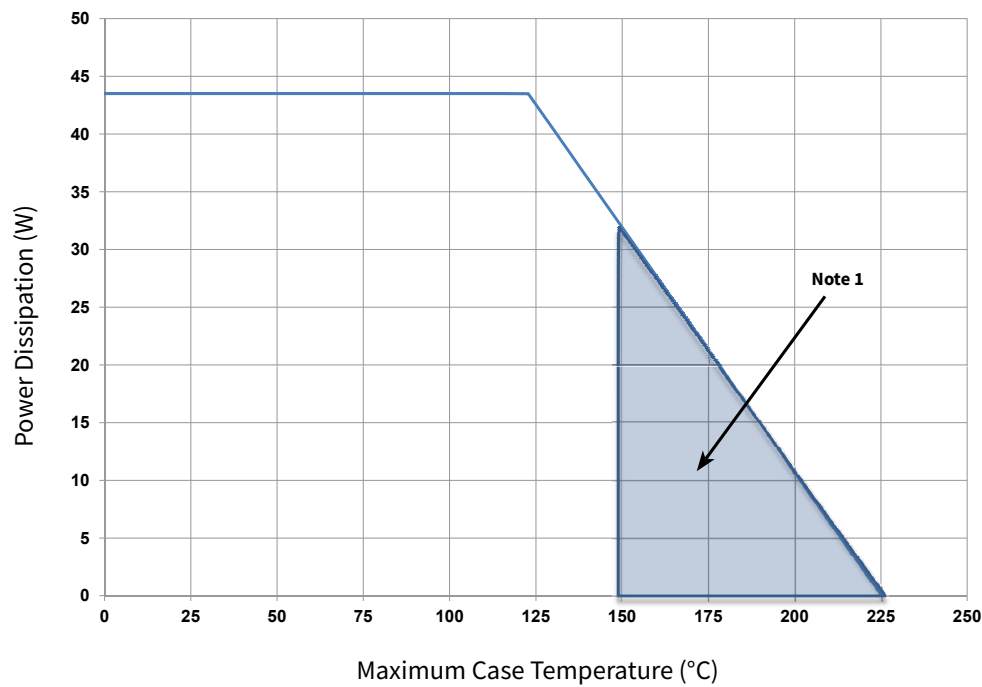


**Figure 11.** PAE vs. Output Power and Frequency  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 800\text{ mA}$ , Pulsed Width = 100 $\mu\text{s}$ , Duty Cycle = 10%



**Figure 12.** Gain vs. Output Power and Frequency  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 800\text{ mA}$ , Pulsed Width = 100 $\mu\text{s}$ , Duty Cycle = 10%

CMPA5585030F Power Dissipation De-rating Curve

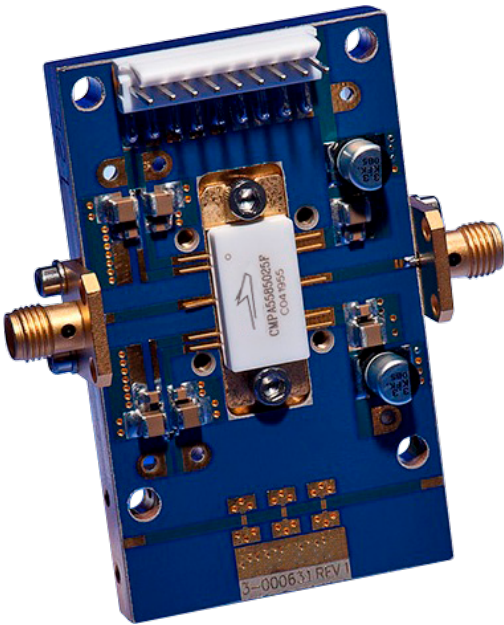


Note:  
<sup>1</sup> Area exceeds Maximum Case Operating Temperature (See Page 2)

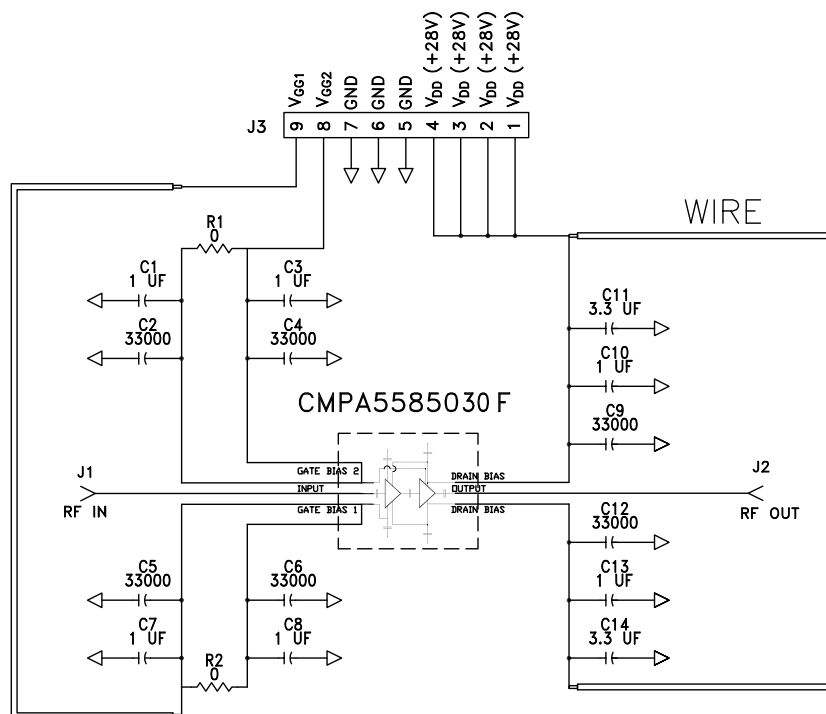
CMPA5585030F-AMP Application Circuit Bill of Materials

| Designator               | Description                                                    | Qty |
|--------------------------|----------------------------------------------------------------|-----|
| C1, C3, C7, C8, C10, C13 | CAP, 1.0μF, +/-10%, 1210, 100V, X7R                            | 6   |
| C2, C4, C5, C6, C9, C12  | CAP, 33000pF, 0805, 100V, X7R                                  | 6   |
| C11, C14                 | CAP ELECT 3.3μF 80V FK SMD                                     | 2   |
| R1, R2                   | RES 0.0 OHM 1/16W 0402 SMD                                     | 2   |
| J1,J2                    | CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL | 2   |
| J3                       | CONNECTOR, HEADER, RT>PLZ .1CEN LK 9POS                        | 1   |
|                          | PCB, TACONIC, RF-35P-0200-CL1/CL1                              | 1   |
| Q1                       | CMPA5585030F                                                   | 1   |

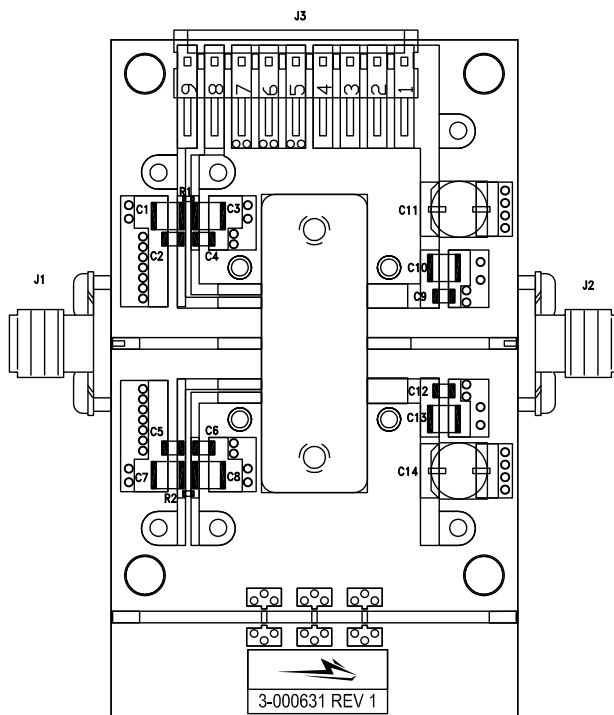
CMPA5585030F-AMP Demonstration Amplifier Circuit



## CMPA5585030F-AMP Demonstration Amplifier Circuit



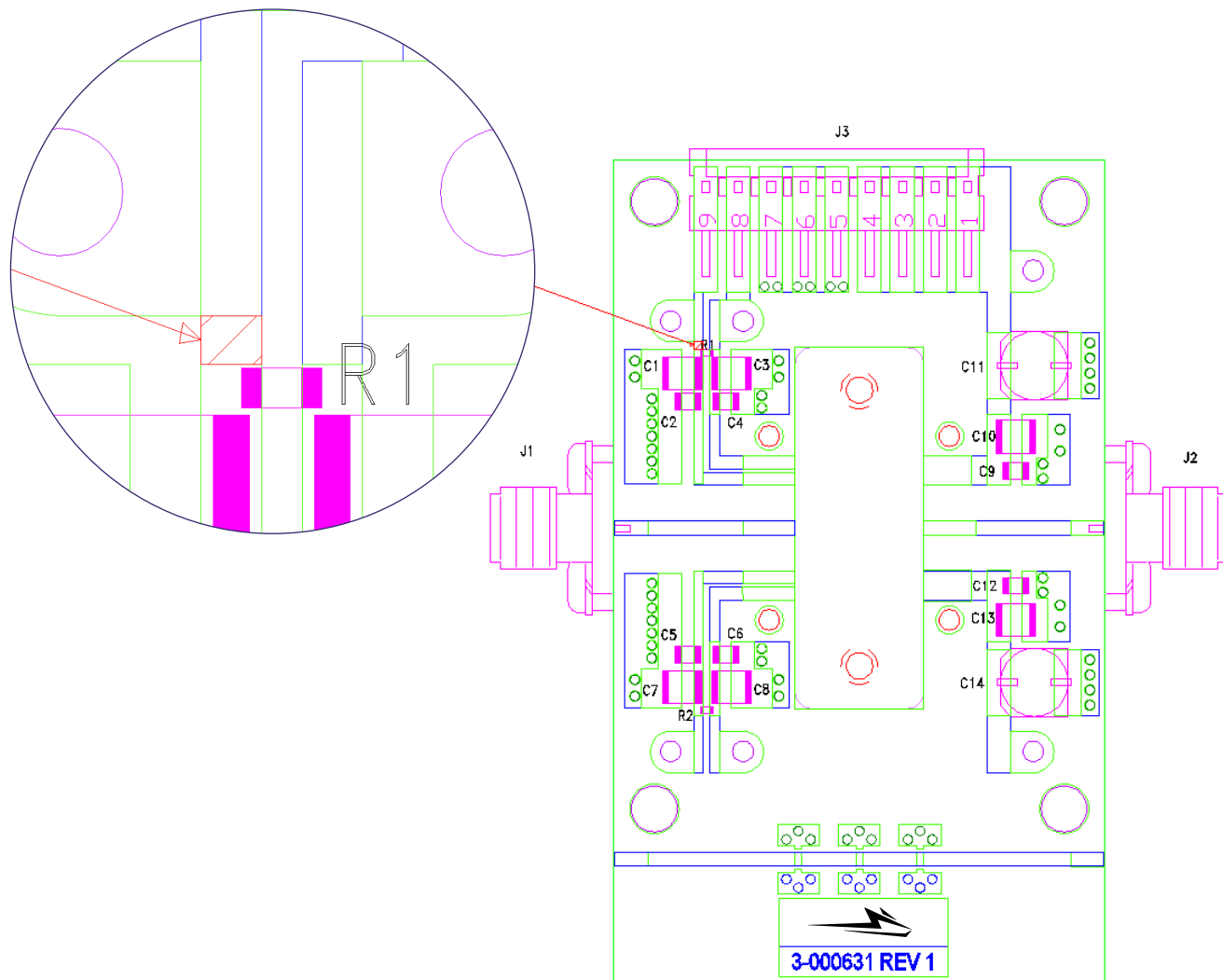
## CMPA5585030F-AMP Demonstration Amplifier Circuit Outline



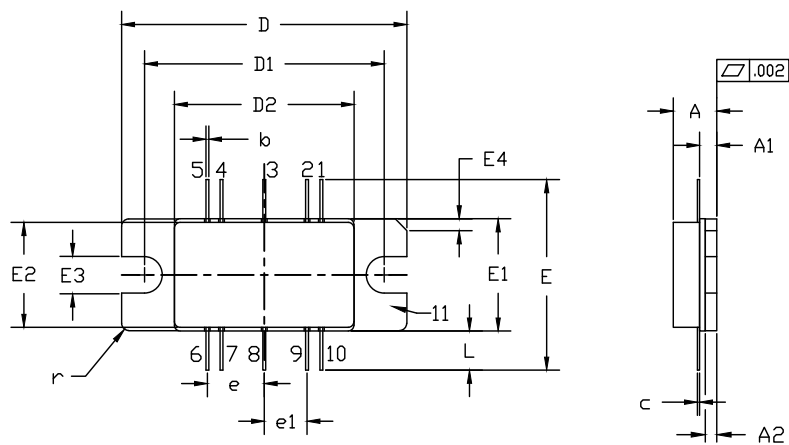


### CMPA5585030F-AMP Demonstration Amplifier Circuit

To configure the CMPA5585030F test fixture to enable independent VG1 / VG2 control of the device, a cut must be made to the microstrip line just above the R1 resistor as shown. Pin 9 will then supply VG1 and Pin 8 will supply VG2.



Product Dimensions CMPA5585030F (Package Type — 440213)

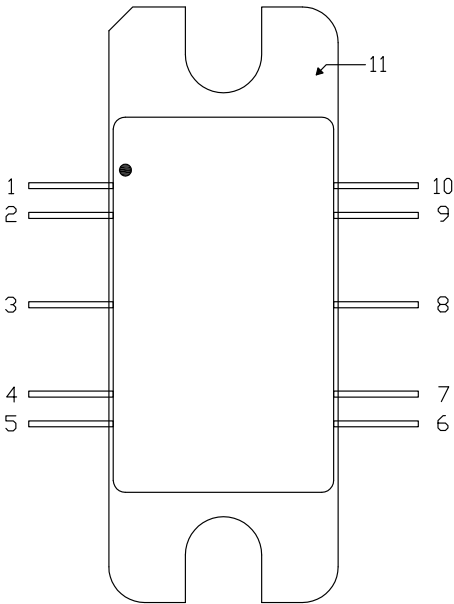


PIN 1: GATE BIAS 6: DRAIN BIAS  
2: GATE BIAS 7: DRAIN BIAS  
3: RF IN 8: RF OUT  
4: GATE BIAS 9: DRAIN BIAS  
5: GATE BIAS 10: DRAIN BIAS  
11: SOURCE

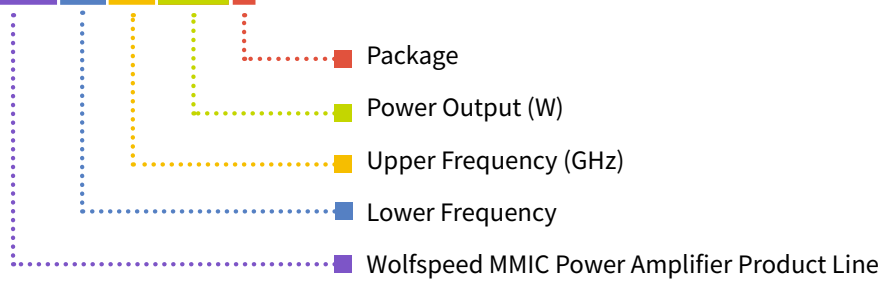
- NOTES:
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M - 1994.
  - 2. CONTROLLING DIMENSION: INCH.
  - 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
  - 4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

| DIM | INCHES |       | MILLIMETERS |       | NOTES       |
|-----|--------|-------|-------------|-------|-------------|
|     | MIN    | MAX   | MIN         | MAX   |             |
| A   | 0.148  | 0.168 | 3.76        | 4.27  |             |
| A1  | 0.055  | 0.065 | 1.40        | 1.65  |             |
| A2  | 0.035  | 0.045 | 0.89        | 1.14  |             |
| b   | 0.01   | TYP   | 0.254       | TYP   | 10x         |
| c   | 0.007  | 0.009 | 0.18        | 0.23  |             |
| D   | 0.995  | 1.005 | 25.27       | 25.53 |             |
| D1  | 0.835  | 0.845 | 21.21       | 21.46 |             |
| D2  | 0.623  | 0.637 | 15.82       | 16.18 |             |
| E   | 0.653  | TYP   | 16.59       | TYP   |             |
| E1  | 0.380  | 0.390 | 9.65        | 9.91  |             |
| E2  | 0.355  | 0.365 | 9.02        | 9.27  |             |
| E3  | 0.120  | 0.130 | 3.05        | 3.30  |             |
| E4  | 0.035  | 0.045 | 0.89        | 1.14  | 45° CHAMFER |
| e   | 0.200  | TYP   | 5.08        | TYP   | 4x          |
| e1  | 0.150  | TYP   | 3.81        | TYP   | 4x          |
| L   | 0.115  | 0.155 | 2.92        | 3.94  | 10x         |
| r   | 0.025  | TYP   | .635        | TYP   | 3x          |

| PIN | Qty                   |
|-----|-----------------------|
| 1   | Gate Bias for Stage 2 |
| 2   | Gate Bias for Stage 2 |
| 3   | RF In                 |
| 4   | Gate Bias for Stage 1 |
| 5   | Gate Bias for Stage 1 |
| 6   | Drain Bias            |
| 7   | Drain Bias            |
| 8   | RF Out                |
| 9   | Drain Bias            |
| 10  | Drain Bias            |
| 11  | Source                |



## Part Number System

**CMPA5585030F****Table 1.**

| Parameter                    | Value  | Units |
|------------------------------|--------|-------|
| Lower Frequency              | 5.5    | GHz   |
| Upper Frequency <sup>1</sup> | 8.5    |       |
| Power Output                 | 30     | W     |
| Package                      | Flange | —     |

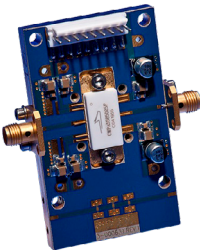
Note:

<sup>1</sup> Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

**Table 2.**

| Character Code | Code Value                     |
|----------------|--------------------------------|
| A              | 0                              |
| B              | 1                              |
| C              | 2                              |
| D              | 3                              |
| E              | 4                              |
| F              | 5                              |
| G              | 6                              |
| H              | 7                              |
| J              | 8                              |
| K              | 9                              |
| Examples       | 1A = 10.0 GHz<br>2H = 27.0 GHz |

Product Ordering Information

| Order Number     | Description                        | Unit of Measure | Image                                                                               |
|------------------|------------------------------------|-----------------|-------------------------------------------------------------------------------------|
| CMPA5585030F     | GaN MMIC                           | Each            |  |
| CMPA5585030F-AMP | Test board with GaN MMIC installed | Each            |  |



**For more information, please contact:**

4600 Silicon Drive  
Durham, NC 27703 USA  
Tel: +1.919.313.5300  
[www.wolfspeed.com/RF](http://www.wolfspeed.com/RF)

Sales Contact  
[RFSales@wolfspeed.com](mailto:RFSales@wolfspeed.com)

RF Product Marketing Contact  
[RFMarketing@wolfspeed.com](mailto:RFMarketing@wolfspeed.com)

## Notes & Disclaimer

---

Specifications are subject to change without notice. “Typical” parameters are the average values expected by Wolfspeed in large quantities and are provided for information purposes only. Wolfspeed products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

©2017-2022 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc.  
PATENT: <https://www.wolfspeed.com/legal/patents>

*The information in this document is subject to change without notice.*